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(71) Applicant *(for all designated States except US)*: **INTEL CORPORATION** [US/US]; 2200 Mission College Boulevard, Santa Clara, California 95052 (US).

(72) Inventors; and

(75) Inventors/Applicants *(for US only)*: **KAMGAING, Telesphor** [CM/US]; 2204 E. Firestone Drive, Chandler, Arizona 85249 (US). **RAO, Valluri R.** [US/US]; 15115 El Quito Way, Saratoga, California 95070 (US).

(74) Agents: **VINCENT, Lester J.** et al.; Blakely Sokoloff Taylor & Zafman, 1279 Oakmead Parkway, Sunnyvale, CA 94085 (US).

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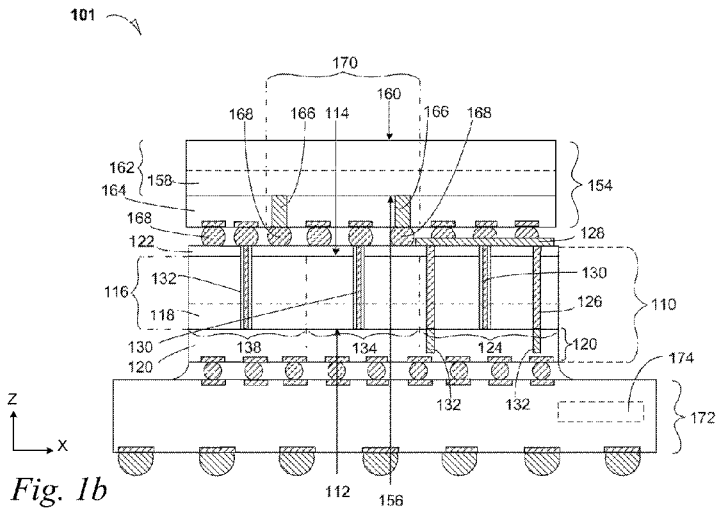


Fig. 1b

(57) Abstract: An apparatus includes a radio-frequency die with shielding through-silicon vias and a die backside lattice lid that shield a sector in the RF die from radio - and electromagnetic interference.

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